



US00D471168S

(12) **United States Design Patent** (10) **Patent No.:** **US D471,168 S**
Ge et al. (45) **Date of Patent:** **** Mar. 4, 2003**

(54) **HEAT DISSIPATING RF ELECTRONICS HOUSING**

(75) Inventors: **David Ge**, Potomac, MD (US);
Mohammed Nusrat Jamal,
Germantown, MD (US)

(73) Assignee: **Teletronics International**, Rockville,
MD (US)

(**) Term: **14 Years**

(21) Appl. No.: **29/152,997**

(22) Filed: **Jan. 7, 2002**

(51) **LOC (7) Cl.** **13-03**

(52) **U.S. Cl.** **D13/184**

(58) **Field of Search** D13/179, 184;
D14/124, 155, 168, 188, 189; 361/271,
274.3, 697, 702, 709, 710, 711, 514; 165/180,
185; 257/706, 707, 718-722; 455/344,
347, 350, 351

(56) **References Cited**

U.S. PATENT DOCUMENTS

4,541,004	A	*	9/1985	Moore	257/706
5,358,032	A	*	10/1994	Arai et al.	165/80.3
5,509,465	A	*	4/1996	Lai	165/80.3
5,581,442	A	*	12/1996	Morosas	361/704
D387,333	S	*	12/1997	Pellow et al.	D13/184
5,862,038	A	*	1/1999	Suzuki et al.	361/704
5,964,285	A	*	10/1999	Huang	165/185
D423,502	S	*	4/2000	Lanclos	D14/188
6,055,159	A	*	4/2000	Sun	361/704
6,295,202	B1	*	9/2001	Tucker et al.	361/704

OTHER PUBLICATIONS

HyperLink Technologies, Inc., "HyperAmp™ HA2401A,"
Jan. 20, 2001, Web Article: www.hyperlinktech.com/html/products/ha2401a.html.

Young Design, Inc., "AMP 2440," Jan. 20, 2001, Web
Article: www.ydi.com/Products/Amplifiers/AMP2440/amp2440.html.

* cited by examiner

Primary Examiner—James Gandy

Assistant Examiner—Selina Sikder

(74) *Attorney, Agent, or Firm*—Cahn & Samuels, LLP

(57) **CLAIM**

The ornamental design for a heat dissipating RF electronics housing, as shown and described.

DESCRIPTION

FIG. 1 is a perspective photographic view from a first side of the electronics housing according to the invention.

FIG. 2 is a perspective photographic view from the opposite side of the housing according to FIG. 1.

FIG. 3 is a top photographic view of the housing according to FIG. 1.

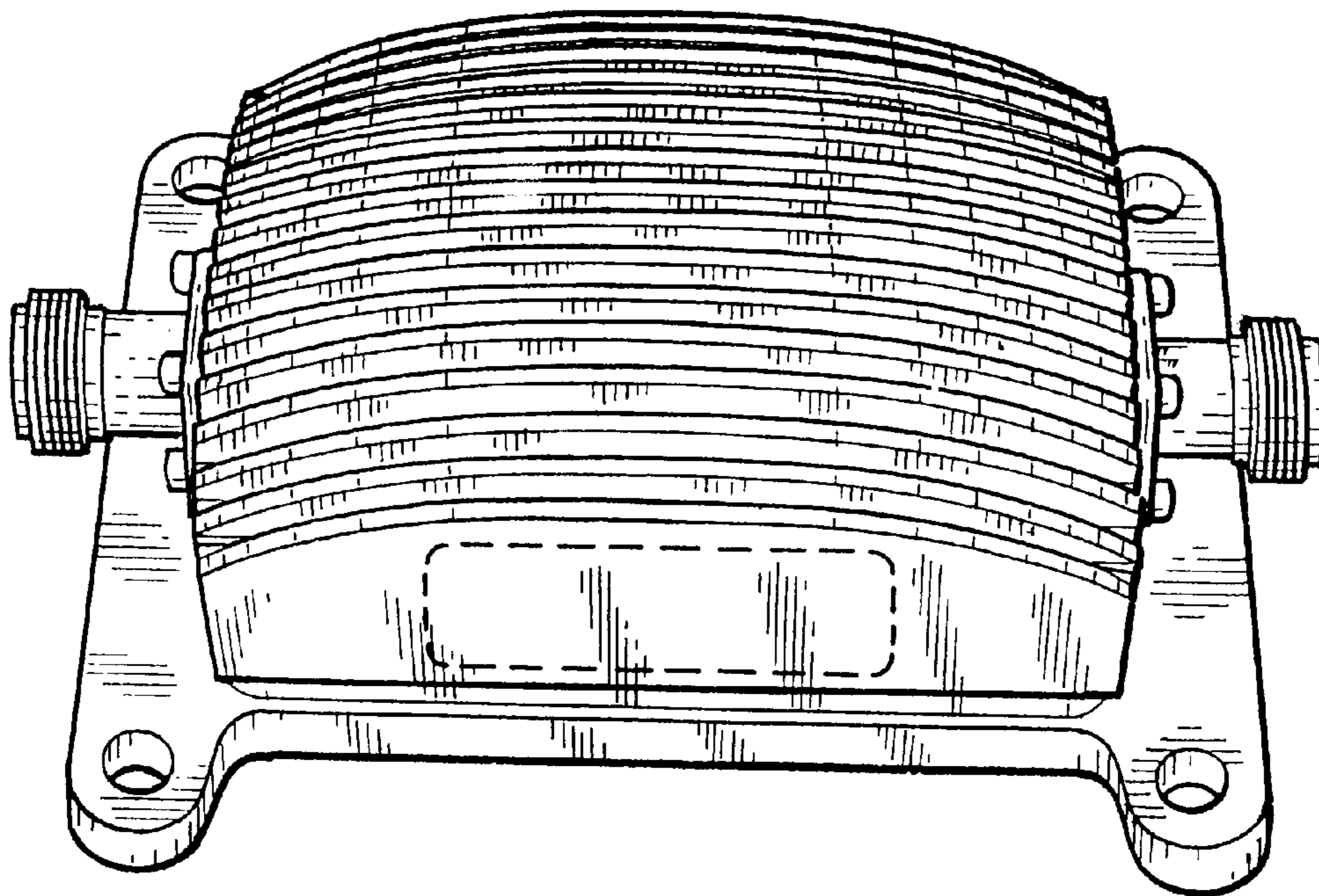
FIG. 4 is a side photographic view of the housing according to FIG. 1.

FIG. 5 is a perspective photographic view from an end of the housing according to FIG. 1.

FIG. 6 is an end view of the housing according to FIG. 5; and,

FIG. 7 is a photographic view of the bottom of the housing according to FIG. 1.

1 Claim, 3 Drawing Sheets



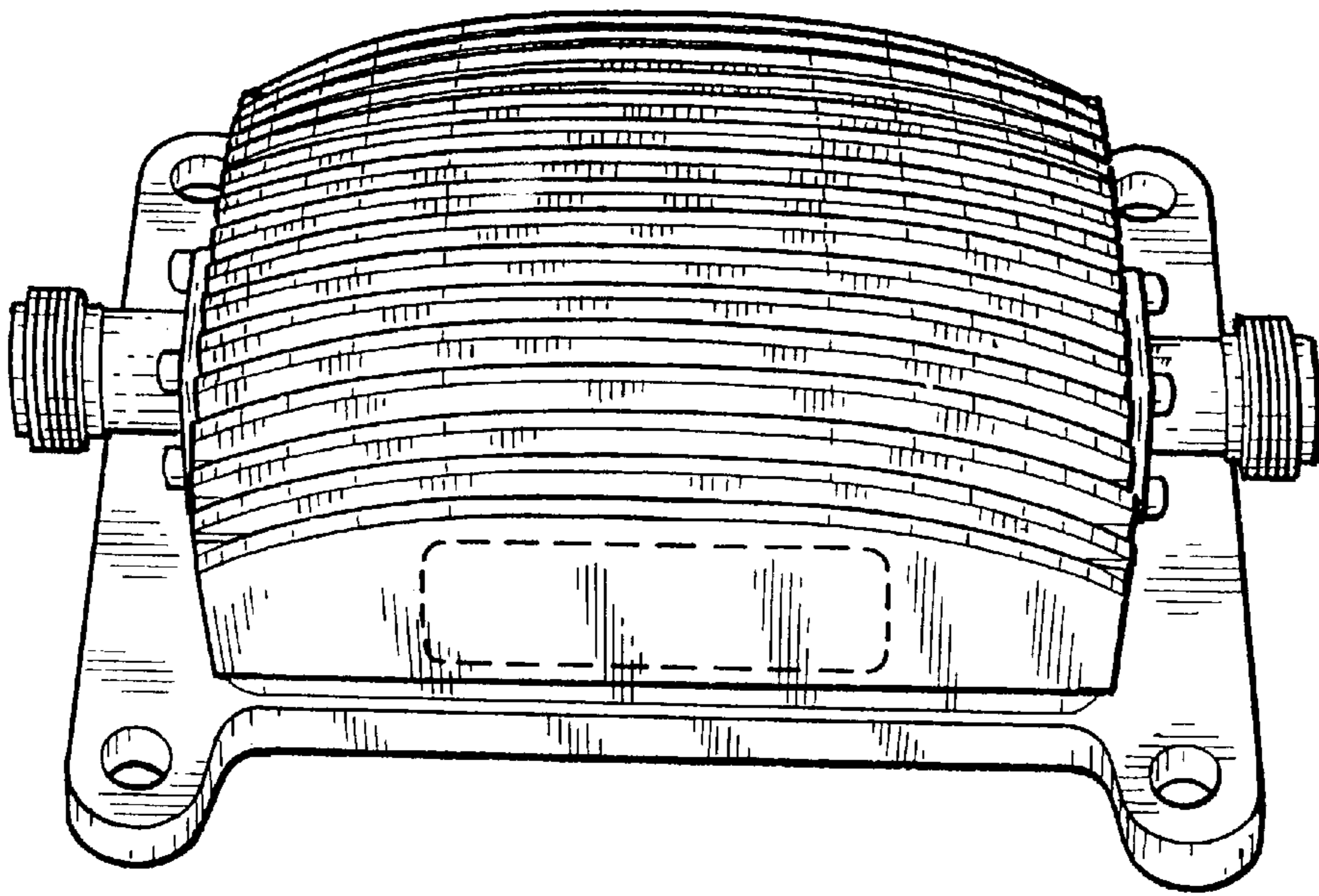


FIG. 1

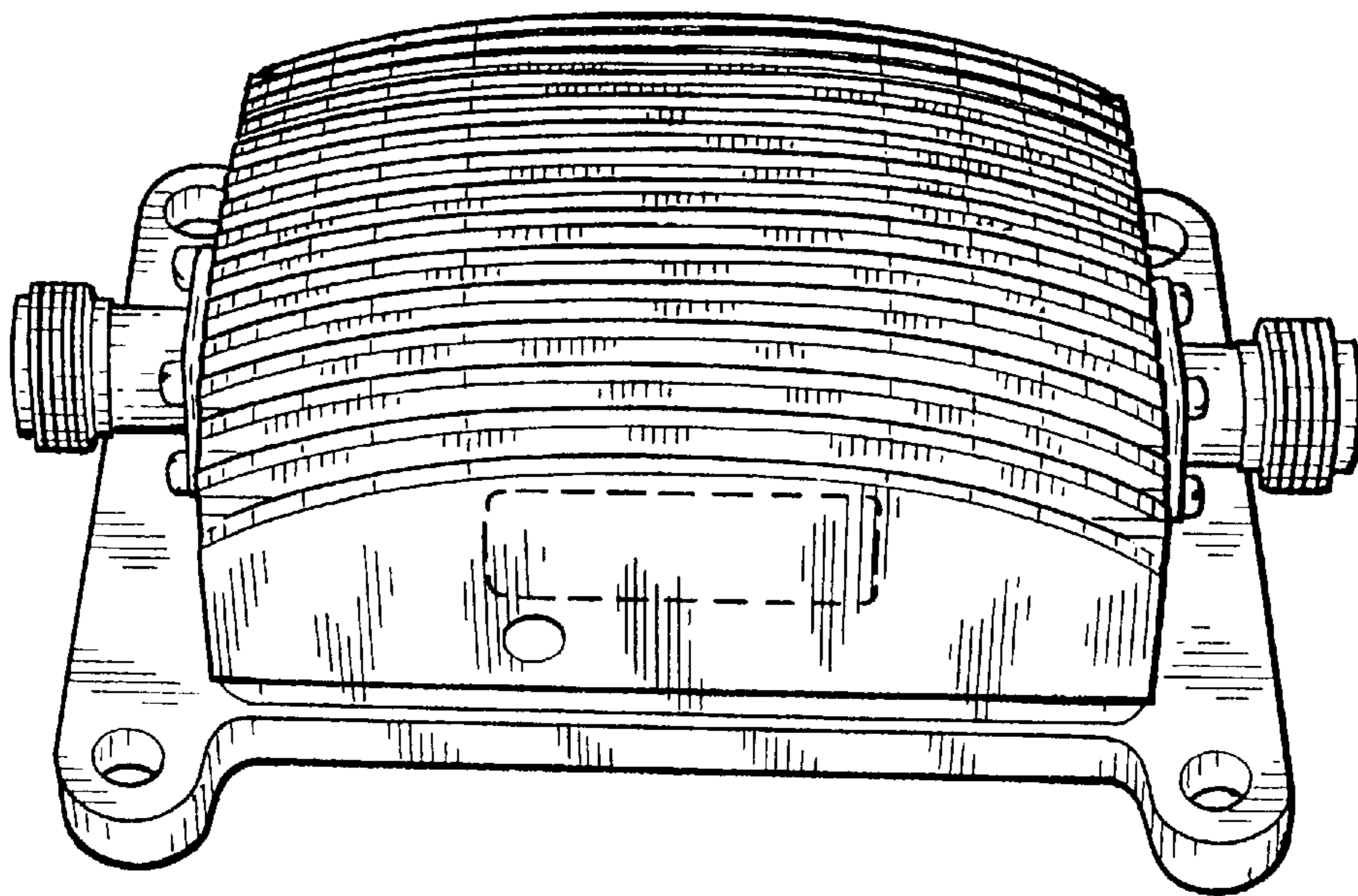


FIG. 2

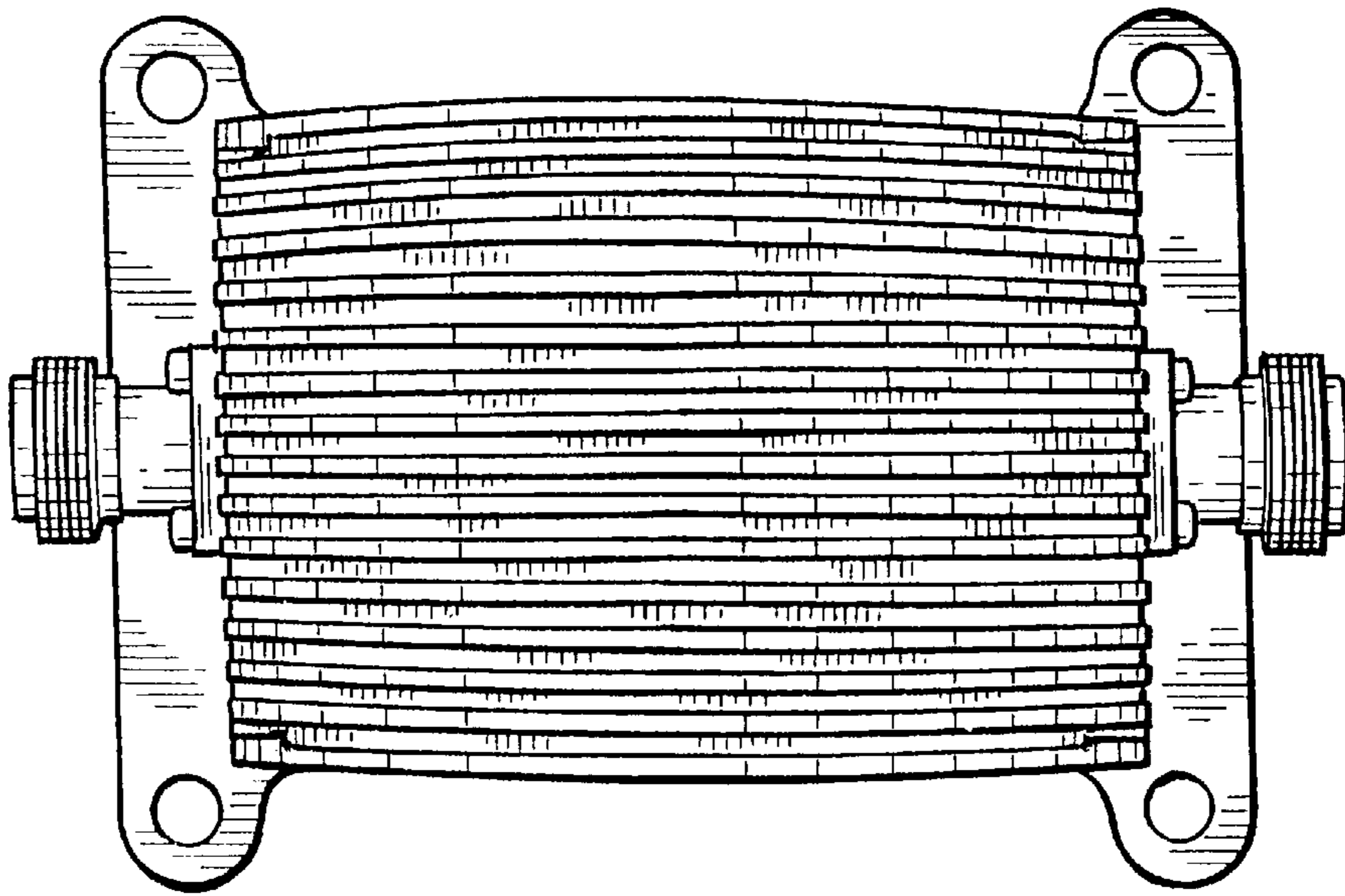


FIG. 3

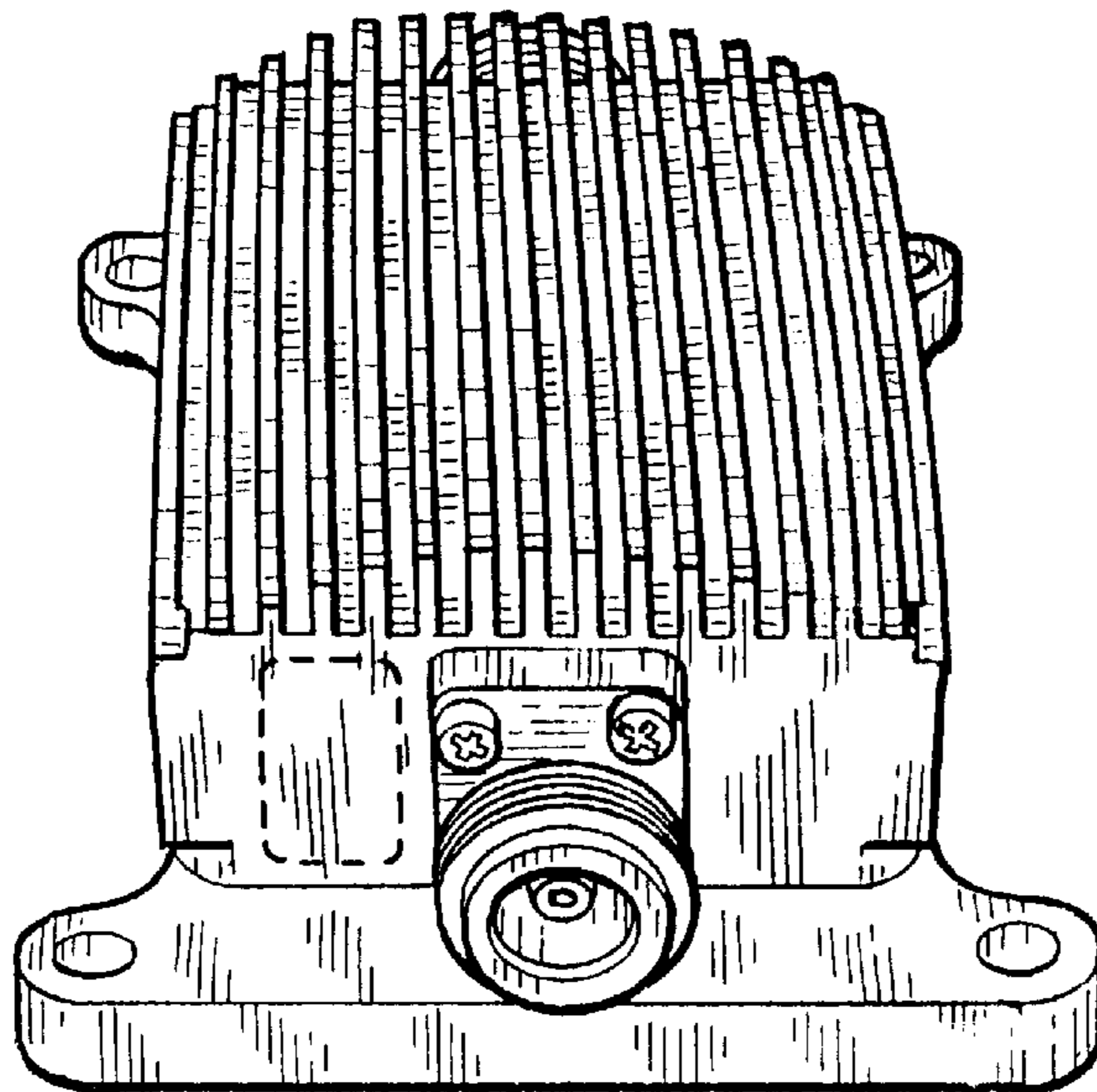


FIG. 5

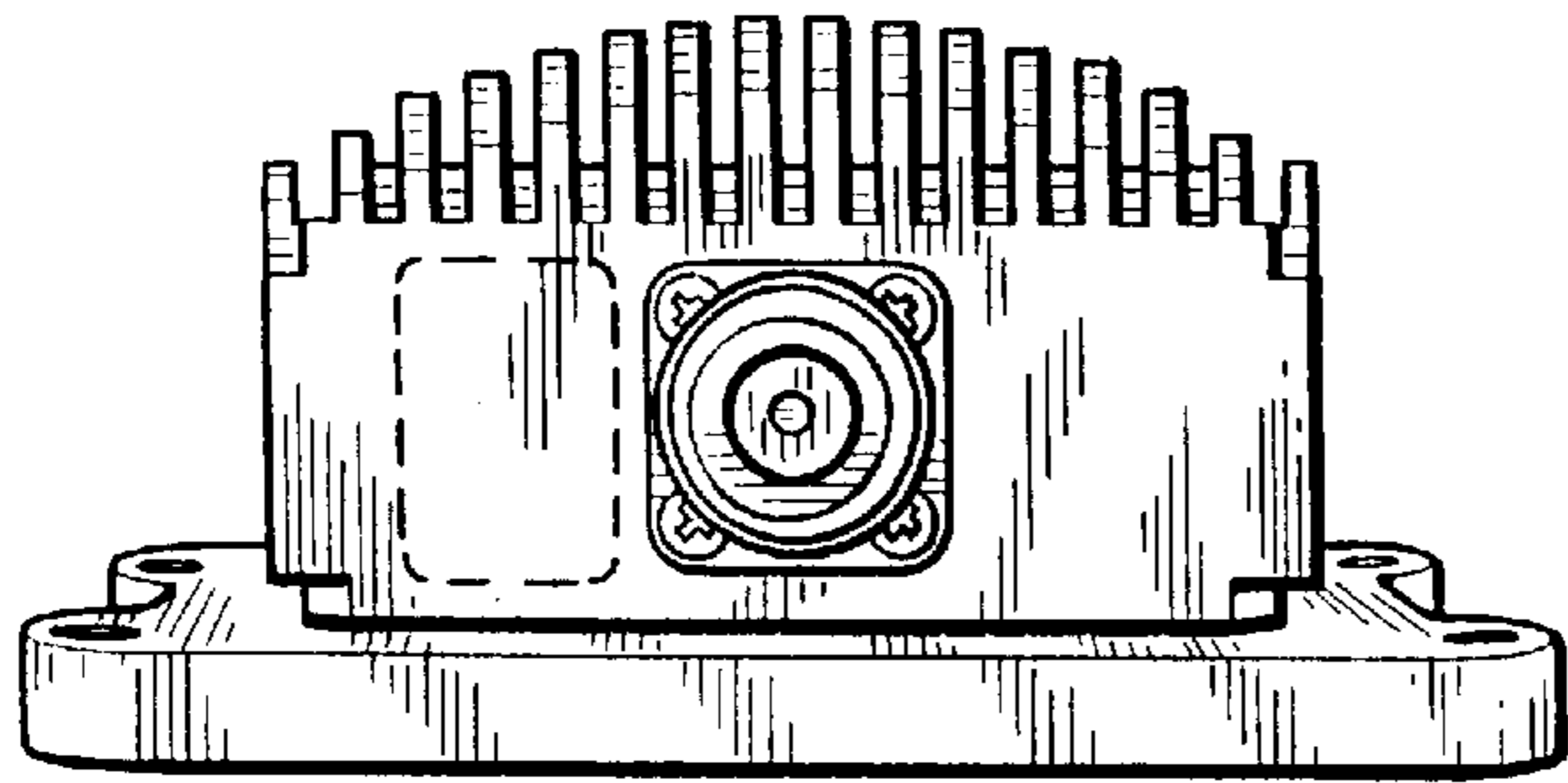


FIG. 6

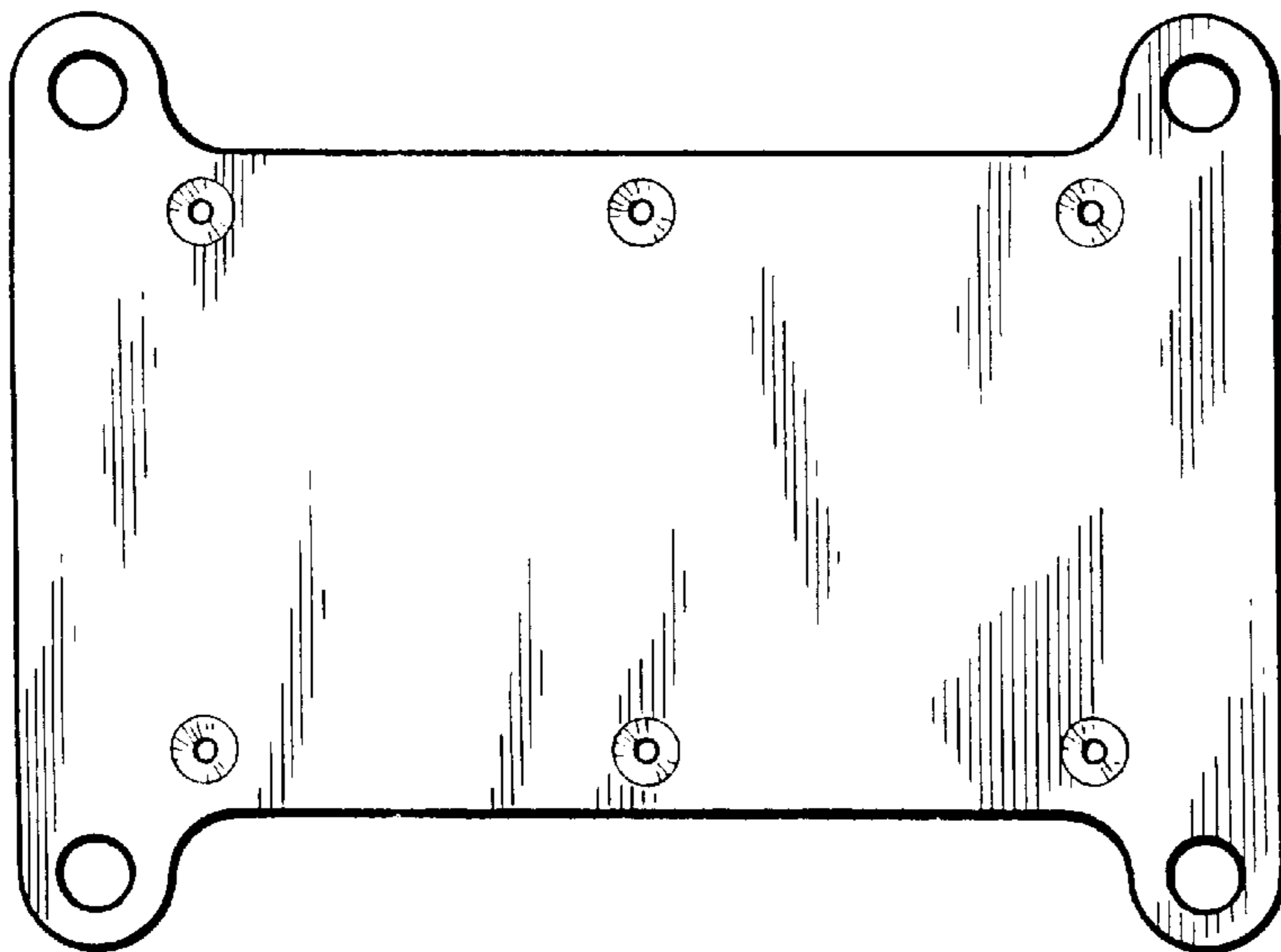


FIG. 7

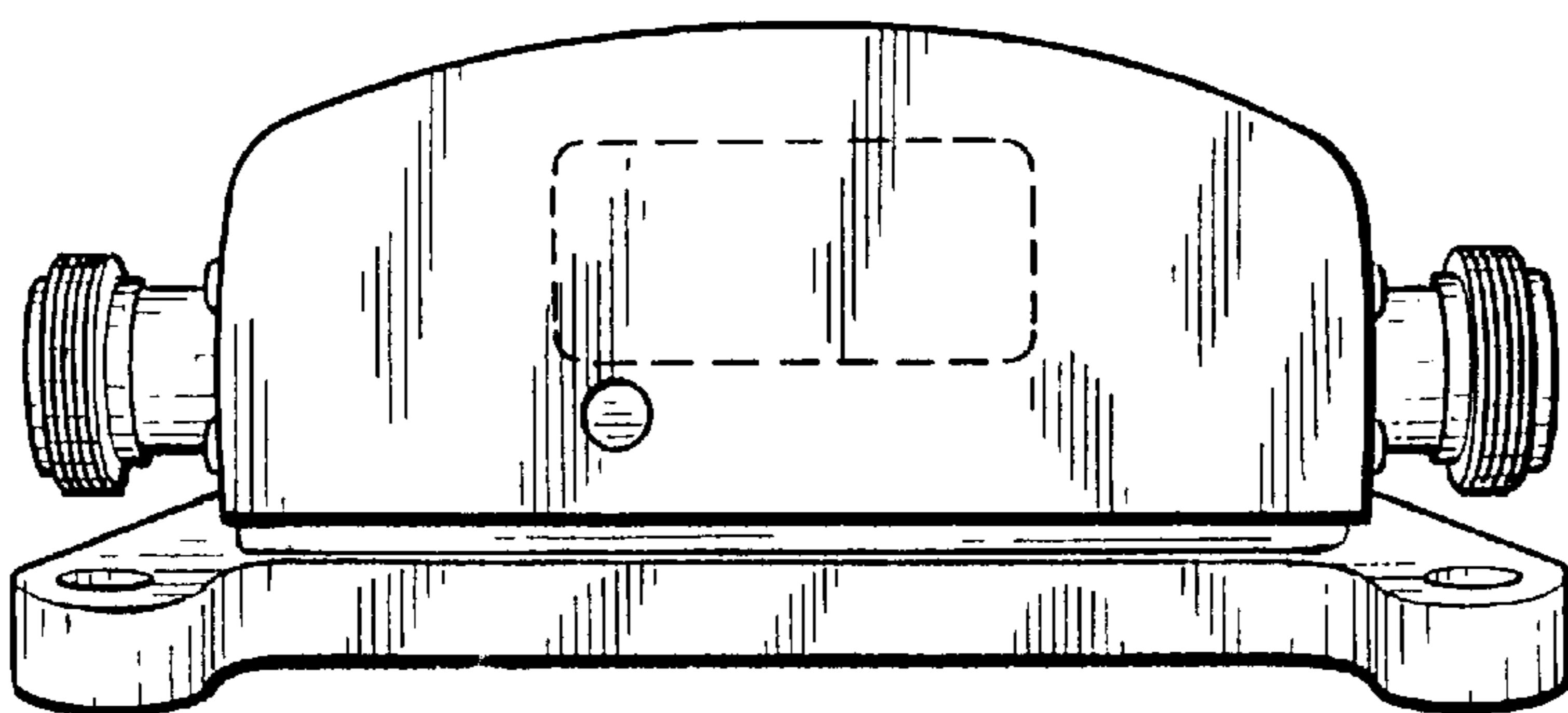


FIG. 4